

Harvatek Top View Chip LEDs Data Sheet B1A53BRG-05C000113U1930

(Preliminary)

Official Product	HT Part No. B1A53BRG-05C000113U1930					
Tentative Product	********	******				
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DISCLAIMER

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HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

Item	Specification	Material	Quantity
Luminous	R: min 360 mcd		
Intensity(Iv)	G: min 715mcd		
	B : min 112.5mcd		
	R/G/B @5mA /T _S = 25°C;Tolerance: <u>+</u> 10%		
Wavelength	R: 615-635nm		
	G: 515~535nm		
	B: 460~480nm		
	R R/G/B @5mA /T _s = 25°C;Tolerance: <u>+</u> 0.5nm		
Vf	R: 1.6-2.6 V		
	G: 2.2-3.2 V		
	B: 2.2-3.2 V		
	R/G/B @5mA / T_s = 25°C; Tolerance: \pm 0.05V		
Ir	< 1 μA @ V _R = 5V		
Resin	Clean	Ероху	
Carrier tape	EIA 481-1A specs	Conductive black tape	3000ea/reel
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/	One reel per bag
		no-zipper	
Carton	HT standard	Paper	Non-specified

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Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note: This is shipped test conditions

*Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection

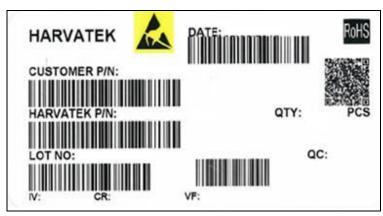


The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must

be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Label Specifications



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Harvatek P/N:

B 1A5 3 BRG- 05C 0003 13

Product	Product Package		Color	Current	Series Number	Taping
PCB	3.2(L)x1.6(W)x1.1(H) mm	3:Single	BRG(Full Color)	5mA	0001~ZZZZ	1.Taping style 2. Q'ty

Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	Α	1	Α	2	2	L	1	2
Code	e 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special code	е
Internal Tra	acing Code	2020-L 2021-M 2022-P 2023-Q 2026-T 2027-V 2030-Y 2031-Z	1:Jan. 2:Feb. A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C 26:Z 27:7 28:8 29:9 30:3 31:4	01-	-ZZ		000~ZZZ	

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Specifications Range

■Luminous Intensity (Iv) Bin:

	HT-B1A53BRG Series									
IV										
	Red			Blue Green			n			
U	360	450	Х	112.5	180	R	715	900		
V	450	560	Υ	180	285	S	900	1125		
W	560	715	Z	285	360	Т	1125	1440		
X	715	900	AA	360	450	U	1440	1800		
Υ	900	1125	AB	450	560	٧	1800	2250		

Note: It maintains a tolerance of ±10% on luminous intensity

■Wavelength Bin:

HT-B1A53BRG Series									
WD									
	Red		Blue Green			1			
Α	615	620	AA	460	465	Α	515	520	
В	620	625	AB	465	470	В	520	525	
С	625	630	AC	470	475	С	525	530	
D	630	635	AD	475	480	D	530	535	

Note: It maintains a tolerance of ±0.5nm on Wavelength Bin

■Forward Voltage (Vf) Bin:

HT-B1A53BRG Series								
Vf								
Red		Blue				Green		
E1A	1.6	2.6	F3A	2.2	3.2	F3A	2.2	3.2

Note: It maintains a tolerance of $\pm 0.05 \text{V}$ on forward voltage measurements

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Product Features

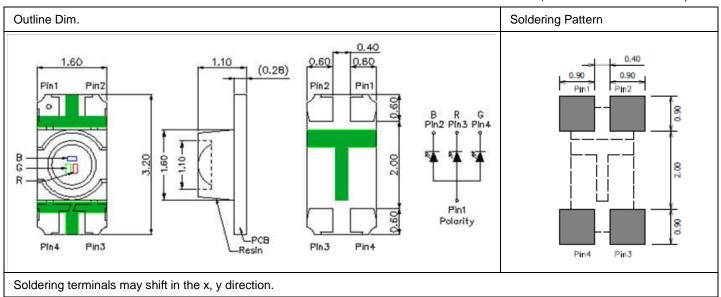
Electro-Optical Characteristics

(T_{Soldering}, 25°C)

Emitting Part number (品號)		Forward Voltage(VF) (順向偏壓)		Wavelength (nm) typ. (波長)			(nm) typ. 光強度	
	(發光色)	typ.	max.	λD	λр	Δλ	typ.	· (發光角)
	Red	1.9	2.6	619	627	13	610	70
B1A53BRG-05C	Blue	2.7	3.2	469	464	18	320	70
	Green	2.5	3.2	529	522	26	1250	70

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit: mm Tolerance: ±/-0.1)



Absolute Maximum Ratings

(T_{Soldering} 25°C)

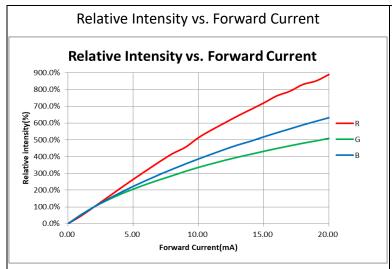
Se	eries	P _D (mW)	I _F (mA)	IFP (mA)	VR	T _{OP} (°C)	T _{ST} (°C)
C.	-1	Dawer Dissipation	Famura ad Commant	Dules Famurand Comment	Daviera Valtara	Operation	Storage
Color Power Dissipa	Power Dissipation	Forward Current	Pulse Forward Current	Reverse Voltage	Temperature	Temperature	
R	ed/	45	F	20	Г	-30~+80	-40~+85
Blue	Hea/ Blue/Green 45		5	20	5	-30 +80	-40 +85

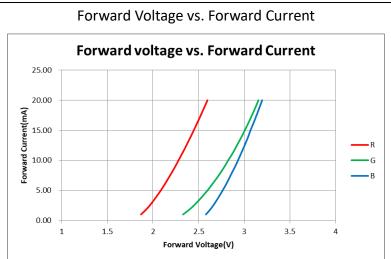
^{*} Condition for IFP is pulse of 1/10 duty and 0.1msec width

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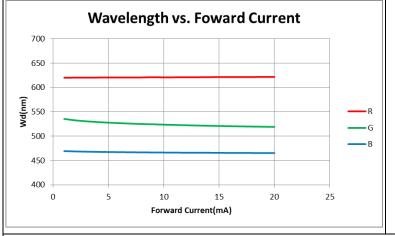


Characteristics of B1A53

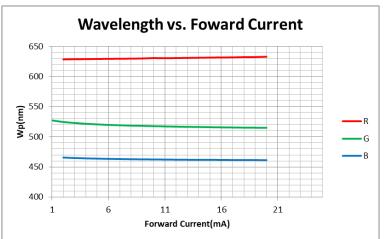




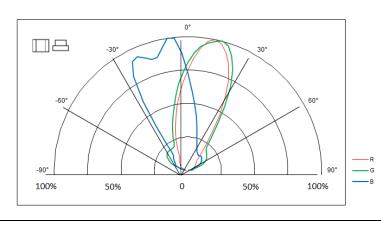


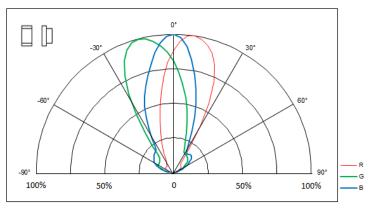


Wavelength vs. Forward Current



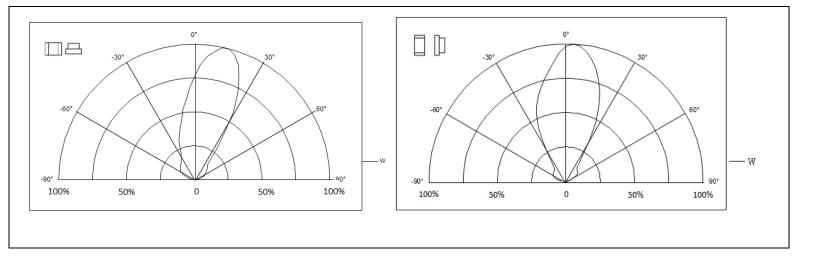
Radiation Diagram





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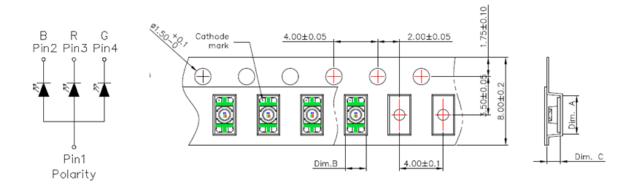
Precaution for Use

- The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

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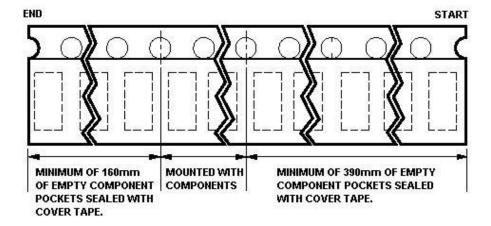


Packaging Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
3.5±0.1	1.88±0.1	1.27±0.1	3000

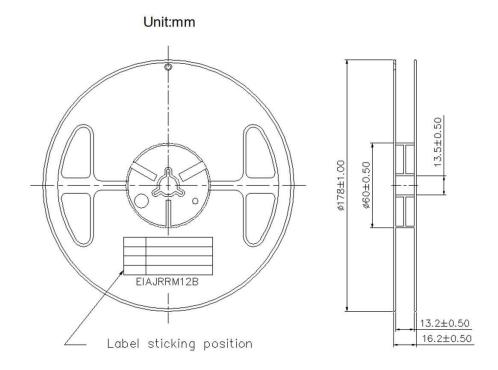
Unit: mm



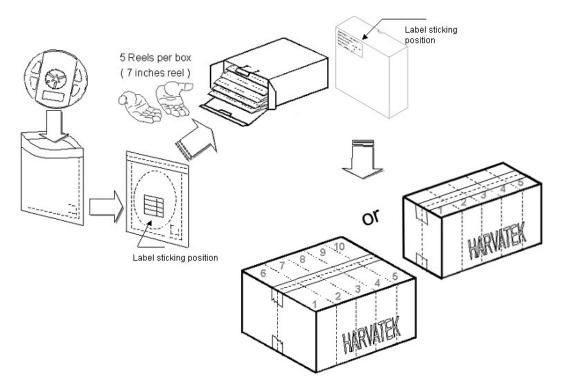
Reel Dimension

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Packing



5 or 10 boxes per carton is available depending on shipment quantity.

Dry Pack

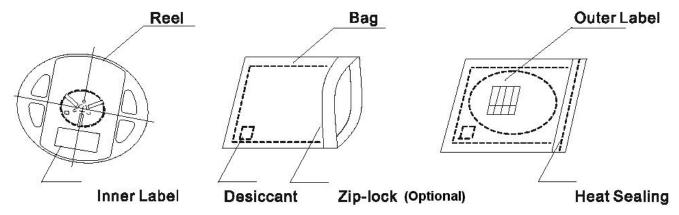
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All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks. The conditions are as followings:

- 1. 60 ± 3 °C ×(12~24hrs)and<5%RH, taped reel type.
- 2. $100\pm3^{\circ}$ C ×(45min~1hr), bulk type.
- 3. $130\pm3^{\circ}$ C×(15min~30min), bulk type.

Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlGaInP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

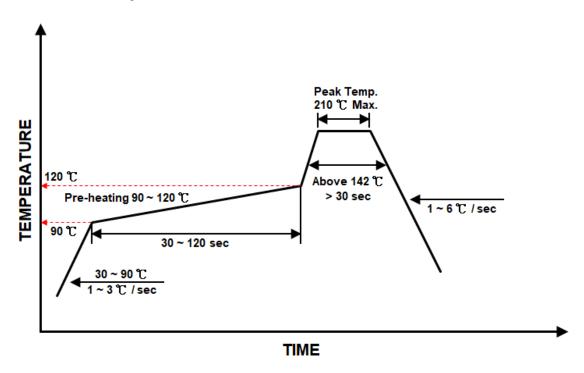
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Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 142°C , >30sec
- 2. Peak temp.:210°C Max.
- 3. Never take next process until the component is cooled down to room temperature after reflow.
- 4. The recommended reflow soldering profile (measuring on the surface of the LED terminal) is following: Lead free Solder Profile
- 5. Reflow soldering should not be done more than two times



Reworking

- Rework should be completed within 5 seconds under 210°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min

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- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

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